

Final Product/Process Change Notification

Document #: FPCN23775ZI Issue Date: 14 Dec 2022

| Title of Change: | S08FL and u8FL Wettable Flank with Dummy Tie Bar Approach & Removal of Dry Pack Process for Automotive MOSFET Devices. | |
|--|--|--|
| Proposed Changed Material First Ship Date: | 21 Jun 2023 or earlier if approved by customer | |
| Current Material Last Order Date: | N/A Orders received after the Current Material Last Order Date expiration are to be considered as orders for new changed material as described in this PCN. Orders for current (unchanged) material after this date will be per mutual agreement and current material inventory availability. | |
| Current Material Last Delivery Date: | N/A The Current Material Last Delivery Date may be subject to change based on build and depletion of the current (unchanged) material inventory | |
| Product Category: | Active components – Discrete components | |
| Contact information: | Contact your local onsemi Sales Office or <u>Ammar.Anuar@onsemi.com</u> | |
| PCN Samples Contact: | Contact your local onsemi Sales Office to place sample order. Sample requests are to be submitted no later than 45 days after publication of this change notification. Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements. | |
| Sample Availability Date: | 23 Dec 2022 | |
| PPAP Availability Date: | 23 Dec 2022 | |
| Additional Reliability Data: | Contact your local onsemi Sales Office or MohdAzizi.Azman@onsemi.com | |
| Type of Notification: | This is a Final Product/Process Change Notification (FPCN) sent to customers. The change will be implemented at 'Proposed Change Material First Ship Date' in compliance to J-STD-46 or ZVEI, or earlier upon customer approval, or per our signed agreements. onsemi will consider this proposed change and it's conditions acceptable, unless an inquiry is made in writing within 45 days of delivery of this notice. To do so, contact PCN.Support@onsemi.com. | |
| Change Category | | |
| Category | Type of Change | |
| Packing/Shipping | Dry pack requirements change | |
| Process - Assembly | Move of all or part of assembly to a different location/site/subcontractor., Change in leadframe dimensions, Change of specified assembly process sequence (deletion and/or additional process step) | |

Description and Purpose:

This Product Change Notification is intended to inform the customer that the Wettable Flank leadframe design and plating process are being enhanced, as tabulated below, in order to improve the sidewall plating and the elimination of Dry Pack.

There is no change to the orderable part number.

There is no product marking change as a result of this change.

| | Before Change | After Change |
|-----------------------------|--|--|
| Wettable Flank Plating Site | Metek, Malaysia (Sub-con) | onsemi Seremban, Malaysia |
| S08FL Lead Frame design | No tie bar connect to the gate and source lead | Additional tie bar connect to gate and source lead |

TEM001794 Rev. G Page 1 of 4



Final Product/Process Change Notification Document #: FPCN23775ZI Issue Date: 14 Dec 2022

| | | 2. Upset lead of 3. Standard fla | | 2. 3. | Flat lead design Larger flag size 1 3 |
|--|--------|--|---------------------------|--|--|
| S08FL Case Outline | | 48 | 8AA | | 507BA |
| S08FL Dimension "L1" in case out | line | 0.12 | 25mm | | 0.15mm |
| u8FL Lead Frame design | | 1. No tie bar of source lead 2. Chamfer flag | onnect to the gate abd | 1. 2. 1 | Additional tie bar connect to gate and source lead Removed chamfer |
| u8FL Case Outline | | 511AB | | | 515AN |
| u8FL Dimension "L" in case outli | ne | 0.30mm – 0.56mm | | 0.30mm – 0.59mm | |
| Sidewall Plating Method | | Electroless SN plating | | Electrolytic SN plating | |
| Packing | | Drypack (MSL 1) | | No Drypack (MSL 1) | |
| | | | | | |
| Reason / Motivation for Change: | Source | /Supply/Capacity Chan | ges Process/Materials Cha | inge | |
| | | fication tests. Potential | impacts | e Product Specification. The device has can be identified, but due to testing verified and excluded. | |
| Sites Affected: | | | | | |
| onsemi Sites | | External Foundry/Subcon Sites | | | |
| onsemi Seremban, Malaysia | | | None | | |
| Marking of Parts/ Traceability of Change: Material will be traceable with | | onsemi lot trace code & | tracking | | |

TEM001794 Rev. G Page 2 of 4



Final Product/Process Change Notification

Document #: FPCN23775ZI Issue Date: 14 Dec 2022

Reliability Data Summary:

QV DEVICE NAME (u8FL PACKAGE QUAL): NVTFS6H850N

RMS: 64634,65635,65199,64753,66669

PACKAGE: u8FL

| Test | Specification | Condition | Interval | Results |
|--------|--|---|-----------|---------|
| HTSL | JESD22-A103 | Ta = 175 °C | 2016 hrs | 0/231 |
| HAST | JESD22 A110 130°C/85% RH ~18.8 psig, bias = 80% of rated V or up to maximum 100V | | 192 hrs | 0/231 |
| TC+PC | JESD22-A104 | Ta = -55°C to +150°C | 1000 cyc | 0/231 |
| UHAST | JESD22-A118 | 130°C, 85% RH, 18.8psig, unbiased | 96 hrs | 0/231 |
| IOL+PC | MIL STD750, M 1037 AEC Q101 | Ta=+25°C, deltaTj=100°C max, Ton = Toff = 2min | 30000 cyc | 0/231 |
| PC | | | | 0/924 |
| RSH | JESD22-B106 | Ta = 265°C, 10 sec | | 0/924 |
| SD | JSTD002 | Ta = 245°C, 10 sec | | 0/45 |

QV DEVICE NAME (S08FL PACKAGE QUAL): NVMFS5830NL

RMS: 67654, 68461, 68052

PACKAGE: u8FL

| Test | Specification | Condition | Interval | Results |
|-----------|------------------|---|-----------|---------|
| HTRB | MILSTD750-1 | Tj= 175°C, V=100% rated V | 1008 Hrs | 0/231 |
| HTGB | JESD22 A108 | Tj= 175°C, Vgs=100%, | 1008 Hrs | 0/231 |
| HTSL | JESD22 A103 | Ta= 175°C | 2016 Hrs | 0/231 |
| TC + PC | JESD22 A104 | Ta = -55°C to +150°C | 1000 cyc | 0/231 |
| UHAST | JESD22 A118 | Ta=130C, 85% RH, ~18.8 psig, no bias | 96 hrs | 0/231 |
| HAST + PC | JESD22 A110 | 130C/85%RH, ~18.8 psig, 80% rated V | 192 hours | 0/231 |
| IOL + PC | MIL-STD-750 | Ta=25C DeltaTj=100C°, t(on)=t(off)= 2 min | 30000 cyc | 0/231 |
| RSH | JESD22 B106 | Ta = 265°C, 10 sec | | 0/90 |
| SD | J-STD-002 , B102 | Ta = 245°C, 10 sec | | 0/45 |

QV DEVICE NAME (S08FL HEFET PACKAGE QUAL): NVMFS6H800NL

RMS: 67648, 68458, 68050

PACKAGE: u8FL

| Test | Specification | Condition | Interval | Results |
|-----------|------------------|---|-----------|---------|
| HTRB | MILSTD750-1 | Tj= 175°C, V=100% rated V | 1008 Hrs | 0/231 |
| HTGB | JESD22 A108 | Tj= 175°C, Vgs=100%, | 1008 Hrs | 0/231 |
| HTSL | JESD22 A103 | Ta= 175°C | 2016 Hrs | 0/231 |
| TC + PC | JESD22 A104 | Ta = -55°C to +150°C | 1000 cyc | 0/231 |
| UHAST | JESD22 A118 | Ta=130C, 85% RH, ~18.8 psig, no bias | 96 hrs | 0/231 |
| HAST + PC | JESD22 A110 | 130C/85%RH, ~18.8 psig, 80% rated V | 192 hours | 0/231 |
| IOL + PC | MIL-STD-750 | Ta=25C DeltaTj=100C°, t(on)=t(off)= 2 min | 30000 cyc | 0/231 |
| RSH | JESD22 B106 | Ta = 265°C, 10 sec | | 0/90 |
| SD | J-STD-002 , B102 | Ta = 245°C, 10 sec | | 0/45 |

Note AEC-1pager is attached.

To view attachments:

- 1. Download pdf copy of the PCN to your computer
- 2. Open the downloaded pdf copy of the PCN
- 3. Click on the paper clip icon available on the menu provided in the left/bottom portion of the screen to reveal the Attachment field

4. Then click on the attached file.

TEM001794 Rev. G Page 3 of 4



Final Product/Process Change Notification

Document #: FPCN23775ZI Issue Date: 14 Dec 2022

| Electrical | Characteristics | Summary | / : |
|------------|-----------------|---------|------------|
|------------|-----------------|---------|------------|

Electrical characteristics are not impacted.

List of Affected Parts:

Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the <u>PCN Customized Portal</u>.

| Current Part Number | New Part Number | Qualification Vehicle |
|---------------------|-----------------|-------------------------------------|
| NVTFS4C06NWFTWG | NA | NVTFS6H850NWFTAG |
| NVMFS5C682NLWFT3G | NA | NVMFS6H800NLWFT1G, NVMFS5830NLWFT1G |
| NVMFS5C682NLWFAFT3G | NA | NVMFS6H800NLWFT1G, NVMFS5830NLWFT1G |
| NVMFS5C673NLWFAFT1G | NA | NVMFS6H800NLWFT1G, NVMFS5830NLWFT1G |
| NVMFS5C638NLWFT1G | NA | NVMFS6H800NLWFT1G, NVMFS5830NLWFT1G |
| NVMFS5C612NWFT1G | NA | NVMFS6H800NLWFT1G, NVMFS5830NLWFT1G |

TEM001794 Rev. G Page 4 of 4